



P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
-60	0.065 @ V _{GS} = -10 V	-5.7			
	0.110 @ V _{GS} = -4.5 V	-4.4			

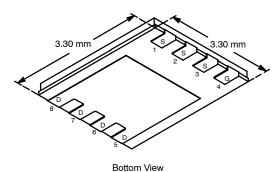
FEATURES

- TrenchFET® Power MOSFET
- New PowerPAK® Package
 - Low Thermal Resistance, RthJC
 - Low 1.07-mm Profile
- Fast Switching



RoHS COMPLIANT

PowerPAK 1212-8

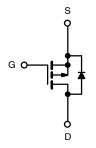


Ordering Information: Si7415DN-T1

Si7415DN-T1-E3 (Lead (Pb)-Free)

APPLICATIONS

- Load Switches
- Half-Bridge Motor Drives
- High voltage Non-Synchronous Buck Converters



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-60		v	
Gate-Source Voltage		V _{GS}	±20		V	
Continuous Drain Current (T,I = 150°C)a	T _A = 25°C	l _D	-5.7	-3.6	A	
Continuous Diam Current (1) = 130 C)-	T _A = 70°C		-4.6	-2.9		
Pulsed Drain Current		I _{DM}	-30		,,	
continuous Source Current (Diode Conduction) ^a		I _S	-3.2	-1.3		
Martine Developing	T _A = 25°C	- P _D	3.8	1.5	W	
Maximum Power Dissipation ^a	T _A = 70°C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	
Soldering Recommendations (Peak Temperature)b,c			260		O	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	R _{thJA}	26	33	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		65	81		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See Solder Profile (http://www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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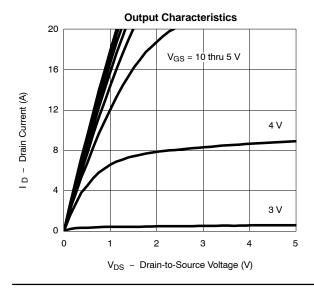


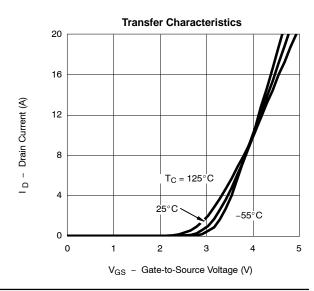
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	nbol Test Condition		Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1		-3	V		
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			±100	nA		
Zono Coto Valtoreo Droin Coment	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ		
Zero Gate Voltage Drain Current		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70^{\circ}\text{C}$			-5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-20			Α		
D : 0	r _{DS(on)}	$V_{GS} = -10 \text{ V}, I_D = -5.7 \text{ A}$		0.054	0.065			
Drain-Source On-State Resistance ^a		$V_{GS} = -4.5 \text{ V}, I_D = -4.4 \text{ A}$		0.090	0.110	Ω		
Forward Transconductance ^a	9fs	$V_{DS} = -15 \text{ V}, I_D = -5.7 \text{ A}$		11		S		
Diode Forward Voltage ^a	V _{SD}	$I_S = -3.2 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V		
Dynamic ^b								
Total Gate Charge	Qg			15	25			
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, \ V_{GS} = -10 \text{ V}, \ I_D = -5.7 \text{ A}$		4		nC		
Gate-Drain Charge	Q _{gd}			3.2				
Turn-On Delay Time	t _{d(on)}			12	20			
Rise Time	t _r	$V_{DD} = -30 \text{ V, R}_{I} = 30 \Omega$		12	20	1		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 6 \Omega$		22	35	ns		
Fall Time	t _f			16	25	1		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -3.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		45	90	1		

Notes a. Pulse test; pulse width $\leq 300 \,\mu s$, duty cycle $\leq 2\%$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





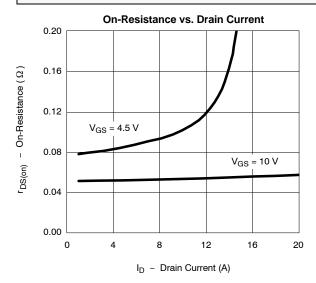
Guaranteed by design, not subject to production testing.

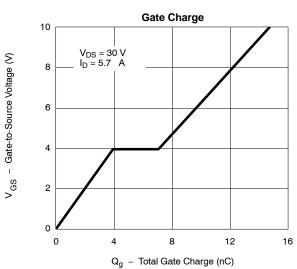


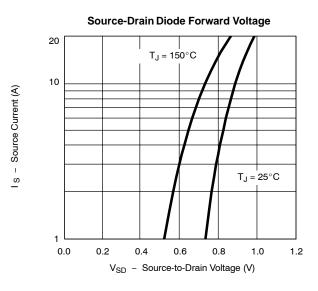


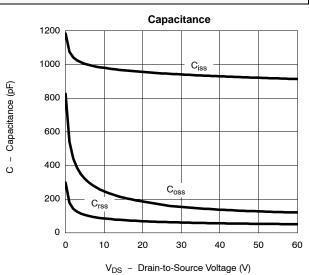
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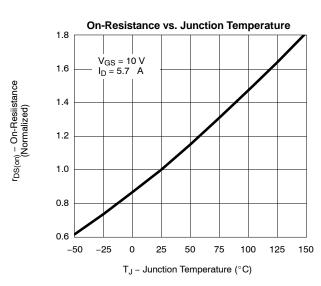
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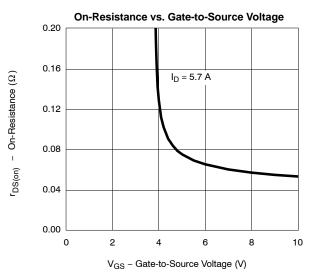








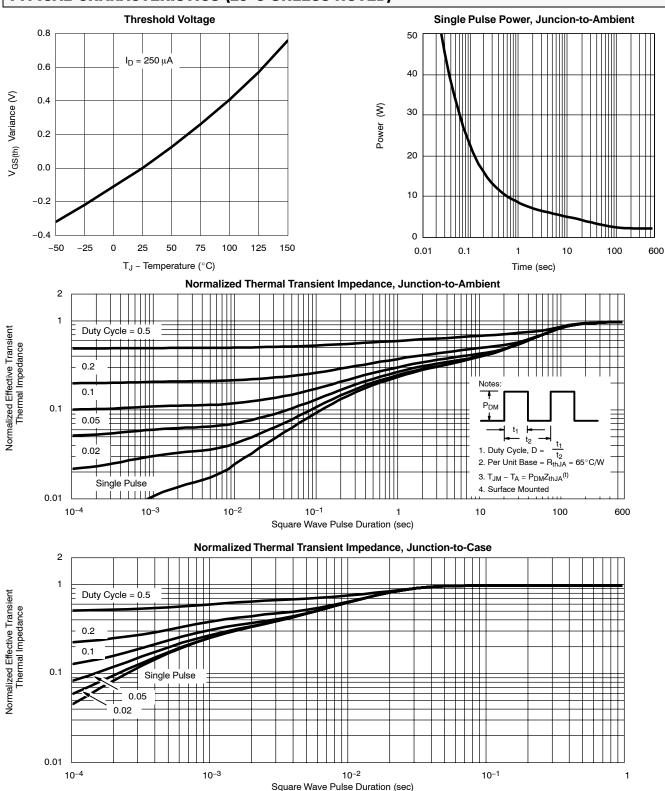




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TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71691.



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